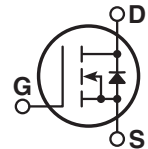
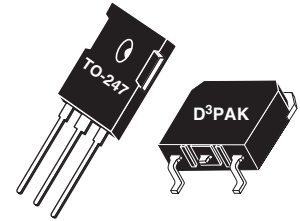




Super Junction MOSFET

- Ultra Low $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge, Q_g
- Avalanche Energy Rated
- Extreme dv/dt Rated
- Popular TO-247 or Surface Mount D³ package.




MAXIMUM RATINGS

All Ratings per die: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT38N60B_SC6	UNIT
V_{DSS}	Drain-Source Voltage	600	Volts
I_D	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	38	Amps
	Continuous Drain Current @ $T_C = 100^\circ\text{C}$	24	
I_{DM}	Pulsed Drain Current ¹	112	
V_{GS}	Gate-Source Voltage Continuous	± 20	Volts
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	278	Watts
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	260	
dv/dt	Drain-Source Voltage slope ($V_{DS} = 480\text{V}$, $I_D = 38\text{A}$, $T_J = 125^\circ\text{C}$)	15	V/ns
I_{AR}	Avalanche Current ²	6.6	Amps
E_{AR}	Repetitive Avalanche Energy ² ($I_D = 6.6\text{A}$, $V_{DD} = 50\text{V}$)	1.2	mJ
E_{AS}	Single Pulse Avalanche Energy ($I_D = 6.6\text{A}$, $V_{DD} = 50\text{V}$)	796	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{(DSS)}$	Drain-Source Breakdown Voltage ($V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$)	600			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance ³ ($V_{GS} = 10\text{V}$, $I_D = 18\text{A}$)			0.099	Ohms
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = 600\text{V}$, $V_{GS} = 0\text{V}$)			25	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 600\text{V}$, $V_{GS} = 0\text{V}$, $T_C = 150^\circ\text{C}$)			100	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$)			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 1.2\text{mA}$)	2.5	3	3.5	Volts

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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Microsemi Website - <http://www.microsemi.com>

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C _{iss}	Input Capacitance	V _{GS} = 0V V _{DS} = 25V f = 1 MHz		2826		pF
C _{oss}	Output Capacitance			2428		
C _{rss}	Reverse Transfer Capacitance			261		
Q _g	Total Gate Charge ⁴	V _{GS} = 10V V _{DD} = 300V I _D = 38A @ 25°C		112		nC
Q _{gs}	Gate-Source Charge			18		
Q _{gd}	Gate-Drain ("Miller") Charge			58		
t _{d(on)}	Turn-on Delay Time	INDUCTIVE SWITCHING V _{GS} = 15V V _{DD} = 400V I _D = 38A @ 25°C R _G = 4.3Ω		14		ns
t _r	Rise Time			29		
t _{d(off)}	Turn-off Delay Time			118		
t _f	Fall Time			69		
E _{on}	Turn-on Switching Energy ⁵	INDUCTIVE SWITCHING @ 25°C V _{DD} = 400V, V _{GS} = 15V I _D = 38A, R _G = 4.3Ω		710		μJ
E _{off}	Turn-off Switching Energy			550		
E _{on}	Turn-on Switching Energy ⁵	INDUCTIVE SWITCHING @ 125°C V _{DD} = 400V, V _{GS} = 15V I _D = 38A, R _G = 4.3Ω		1100		
E _{off}	Turn-off Switching Energy			625		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I _S	Continuous Source Current (Body Diode)			33	Amps
I _{SM}	Pulsed Source Current ¹ (Body Diode)			112	
V _{SD}	Diode Forward Voltage ³ (V _{GS} = 0V, I _S = -38A)			1.3	Volts
dv/dt	Peak Diode Recovery dv/dt ⁶			8	V/ns
t _{rr}	Reverse Recovery Time (I _S = -38A, di/dt = 100A/μs)	T _J = 25°C		667	ns
Q _{rr}	Reverse Recovery Charge (I _S = -38A, di/dt = 100A/μs)	T _J = 25°C		18	μC
I _{RPM}	Peak Recovery Current (I _S = -38A, di/dt = 100A/μs)	T _J = 25°C		49	Amps

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R _{θJC}	Junction to Case			0.45	°C/W
R _{θJA}	Junction to Ambient			40	

- 1 Repetitive Rating: Pulse width limited by maximum junction temperature
- 2 Repetitive avalanche causes additional power losses that can be calculated as $P_{AV} = E_{AR} \cdot f$. Pulse width tp limited by Tj max.
- 3 Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%
- 4 See MIL-STD-750 Method 3471
- 5 Eon includes diode reverse recovery.
- 6 Maximum 125°C diode commutation speed = di/dt 600A/μs

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

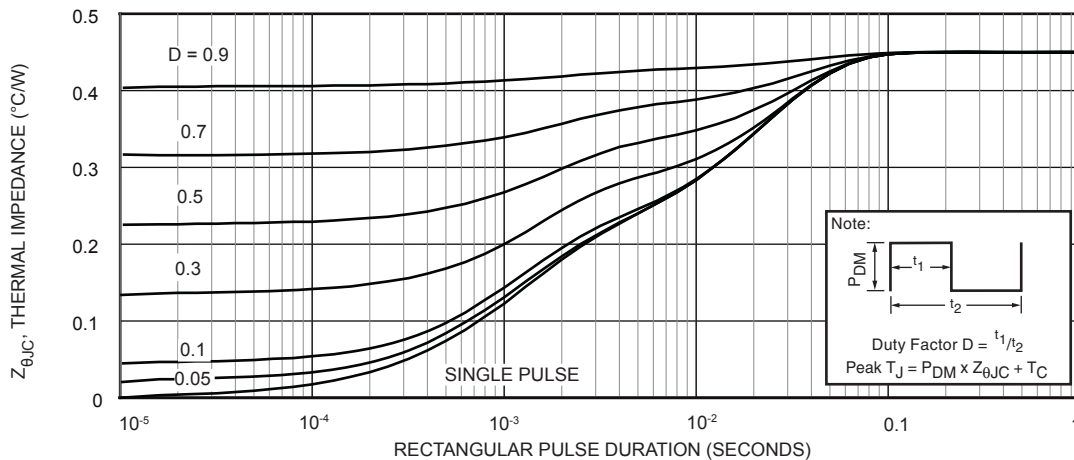


Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

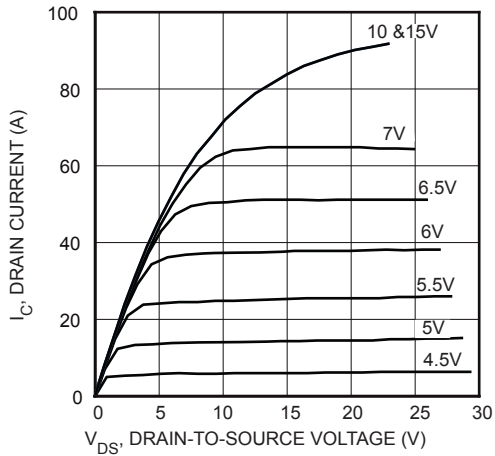


FIGURE 2, Low Voltage Output Characteristics

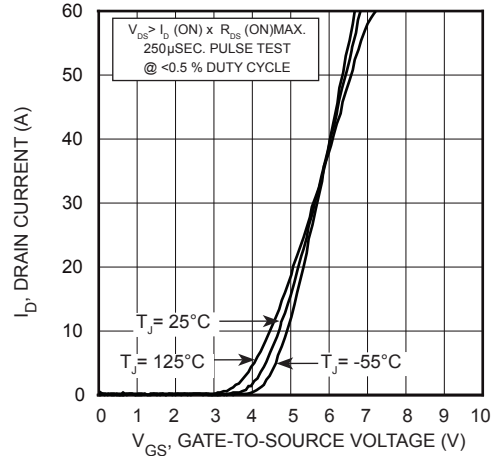


FIGURE 3, Transfer Characteristics

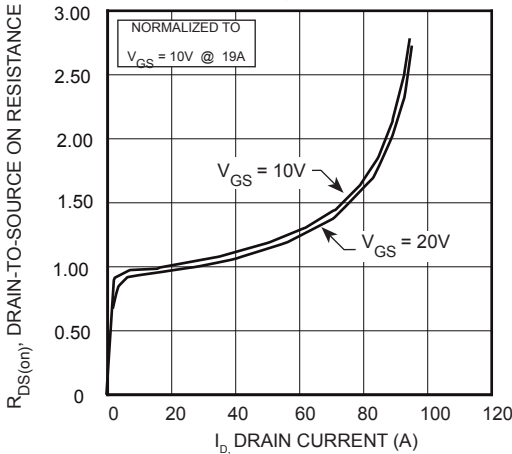


FIGURE 4, $R_{DS(ON)}$ vs Drain Current

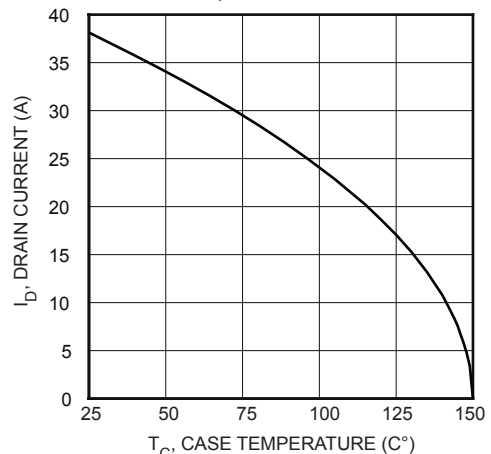


FIGURE 5, Maximum Drain Current vs Case Temperature

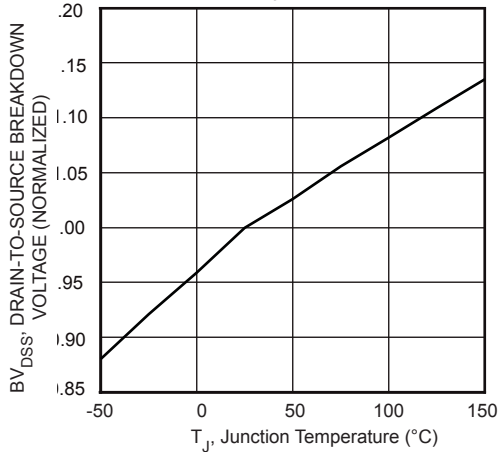


FIGURE 6, Breakdown Voltage vs Temperature

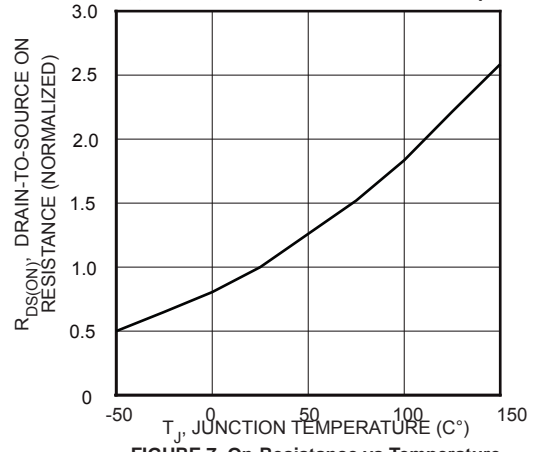


FIGURE 7, On-Resistance vs Temperature

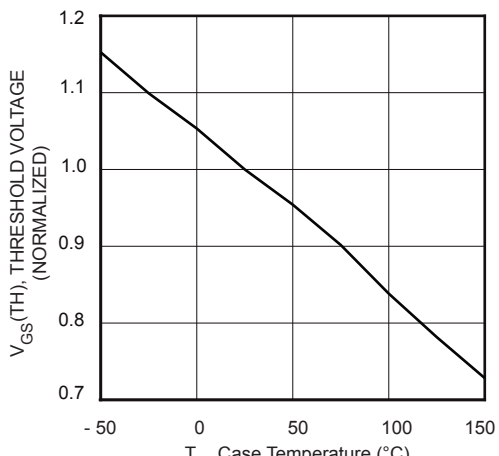


FIGURE 8, Threshold Voltage vs Temperature

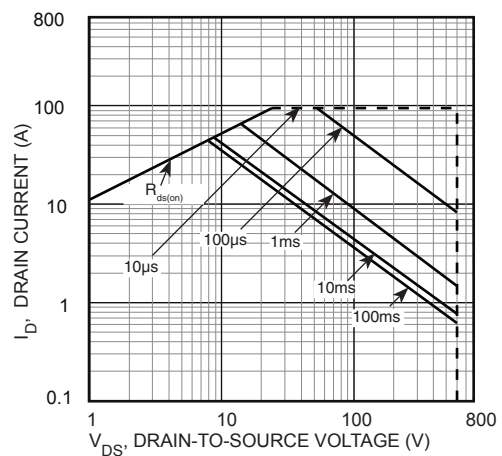


FIGURE 9, Maximum Safe Operating Area

Typical Performance Curves

APT38N60B_SC6

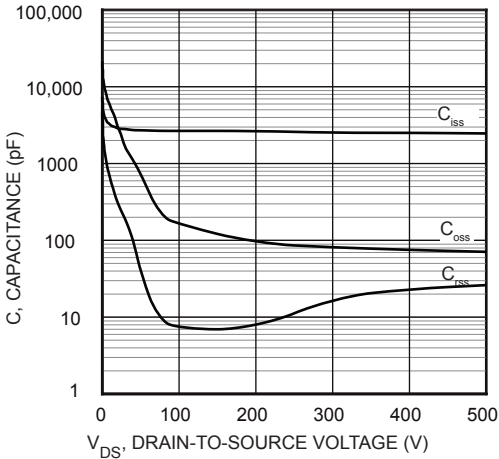


FIGURE 10, Capacitance vs Drain-To-Source Voltage

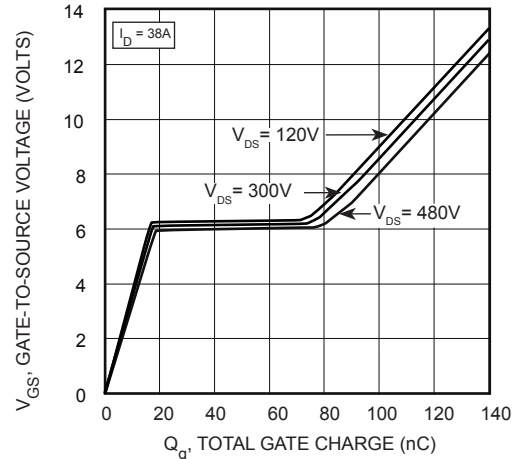


FIGURE 11, Gate Charges vs Gate-To-Source Voltage

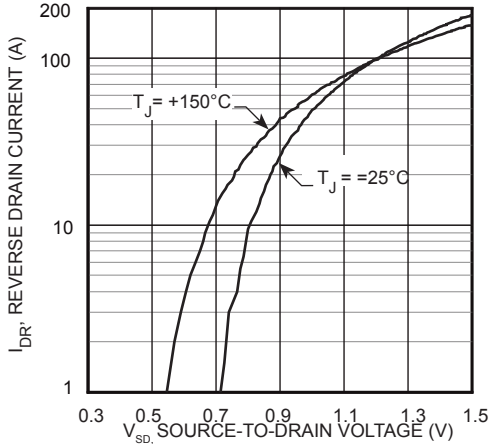


FIGURE 12, Source-Drain Diode Forward Voltage

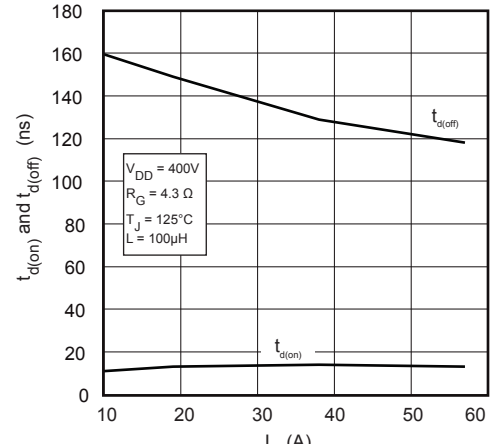


FIGURE 13, Delay Times vs Current

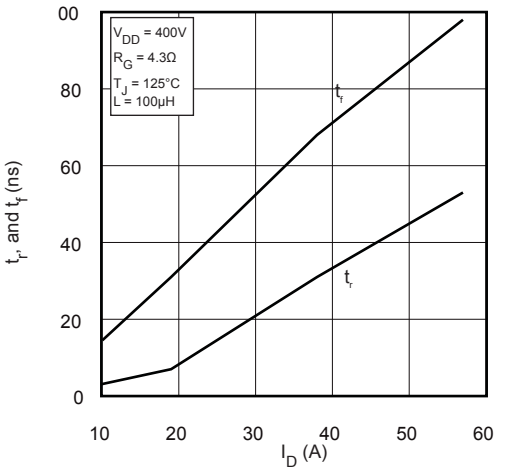


FIGURE 14, Rise and Fall Times vs Current

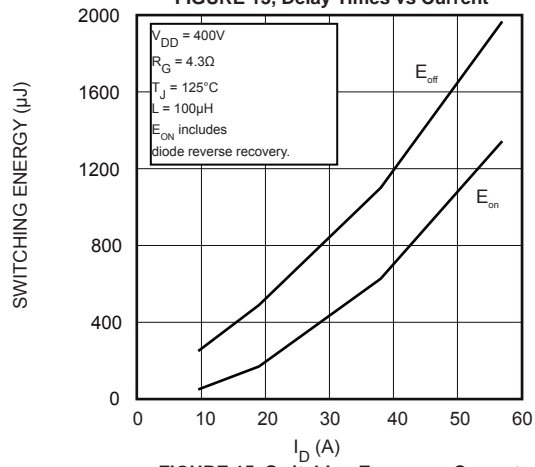


FIGURE 15, Switching Energy vs Current

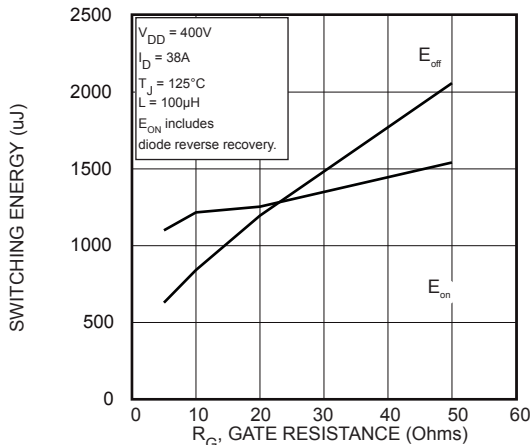


FIGURE 16, Switching Energy vs Gate Resistance

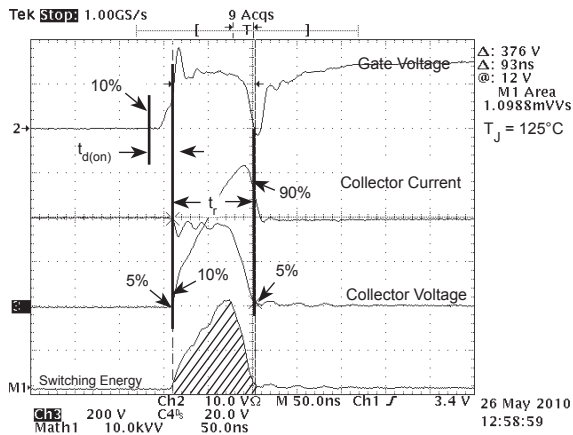


Figure 17, Turn-on Switching Waveforms and Definitions

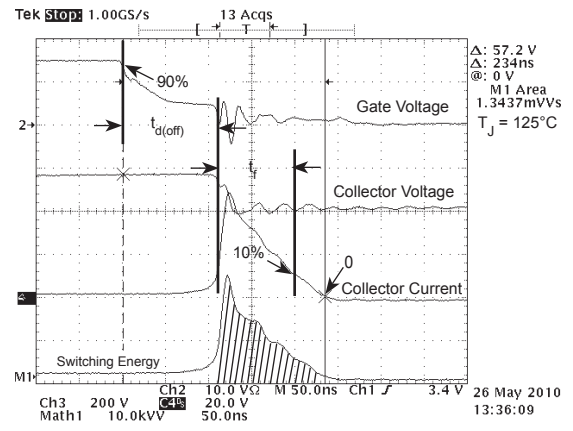


Figure 18, Turn-off Switching Waveforms and Definitions

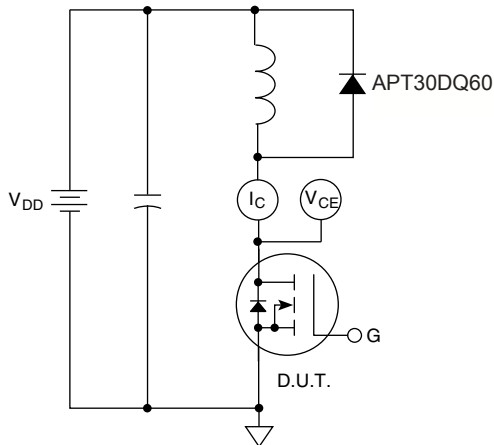
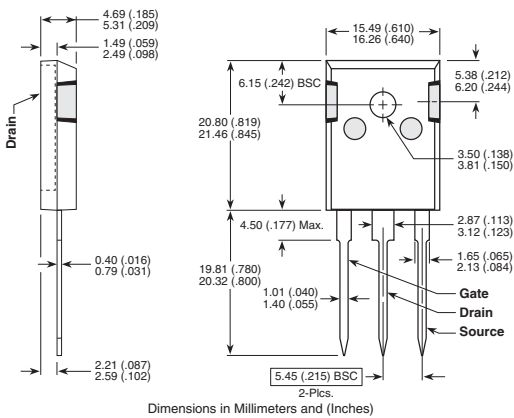


Figure 19, Inductive Switching Test Circuit

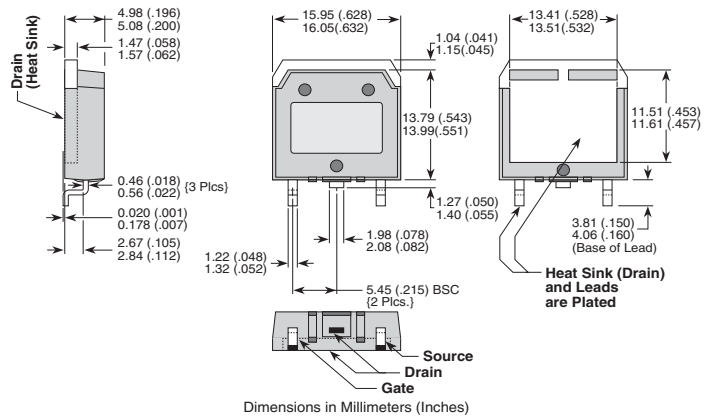
TO-247 (B) Package Outline



Dimensions in Millimeters and (Inches)

D³PAK Package Outline

ⓔ3 100% Sn Plated



Dimensions in Millimeters (Inches)



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- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Защита от снятия компонента с производства.



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